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#### **DUAL 50V NPN LOW SATURATION SWITCHING TRANSISTOR**

### **Features and Benefits**

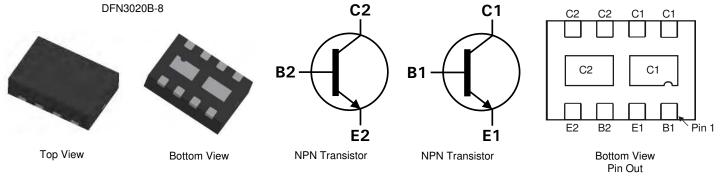
- BV<sub>CEO</sub> > 50V
- I<sub>C</sub> = 4A Continuous Collector Current
- Low Saturation Voltage (100mV max @ 1A)
- $R_{SAT} = 68m\Omega$  for Low Equivalent On Resistance
- h<sub>FE</sub> specified up to 6A for high current gain holds up
- Dual NPN saving footprint and component count
- Low profile 0.8mm high package for thin applications
- R<sub>0.JA</sub> efficient, 40% lower than SOT26
- 6mm<sup>2</sup> footprint, 50% smaller than TSOP6 and SOT26
- Lead-Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: DFN3020B-8
- Case Material: Molded Plastic. "Green" Molding Compound.
- Terminals: Pre-Plated NiPdAu leadframe.
- UL Flammability Rating 94V-0
- Nominal package height: 0.8mm
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.013 grams (approximate)

### **Applications**

- DC DC Converters
- MOSFET gate drivers
- Charging circuits
- Motor Control
- Power switches
- Portable applications



**Equivalent Circuit** 

### Ordering Information (Note 3)

Ī	Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
	ZXTD619MCTA	DCC	7	8	3,000

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com 3. For Packaging Details, go to our website at http://www.diodes.com.

## **Marking Information**



DCC = Product type Marking Code Top view, dot denotes Pin 1





## Maximum Ratings @TA = 25°C unless otherwise specified

Parameter	Symbol	Limit	Unit
Collector-Base Voltage	$V_{CBO}$	100	V
Collector-Emitter Voltage	$V_{CEO}$	50	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Peak Pulse Current	I <sub>CM</sub>	6	Α
Continuous Collector Current (Note 4 and 7)	Ic	4	Α
Base Current	lΒ	1	Α

## Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
	(Notes 4 & 7)		1.5 12	
Power Dissipation	(Notes 5 & 7)		2.45 19.6	W
Linear Derating Factor	(Notes 6 & 7)	P <sub>D</sub>	1.13 8	mW/°C
	(Notes 6 & 8)	Ι Γ	1.7 13.6	
	(Notes 4 & 7)		83.3	
Thermal Resistance, Junction to Ambient	(Notes 5 & 7)	1 5	51.0	
Thermal Resistance, Junction to Ambient	(Notes 6 & 7)	$R_{\theta JA}$	111	°C/W
	(Notes 6 & 8)		73.5	
Thermal Resistance, Junction to Lead (Notes 7 & 9)		$R_{ heta JL}$	17.1	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes:

- 4. For a dual device surface mounted on 28mm x 28mm (8cm²) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed collector pads connected to each half.

  5. Same as note (4), except the device is measured at t <5 sec.

  6. Same as note (4), except the device is surface mounted on 31mm x 31mm (10cm²) FR4 PCB with high coverage of single sided 1oz copper.

  7. For a dual device with one active die.

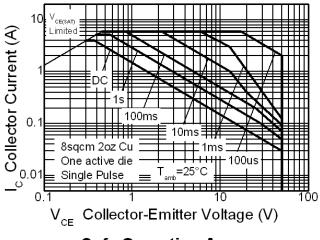
  8. For dual device with 2 active die running at equal power.

  9. Thermal resistance from junction to solder point (at the end of the collector lead).

- 9. Thermal resistance from junction to solder-point (at the end of the collector lead).

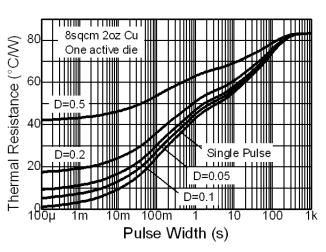


### **Thermal Characteristics**

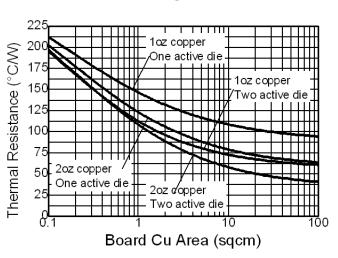


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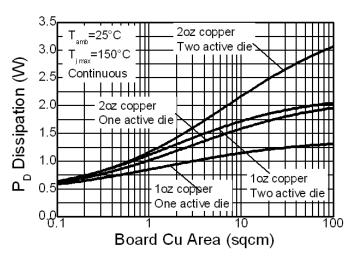
## Safe Operating Area



**Derating Curve** 



## **Transient Thermal Impedance**



Thermal Resistance v Board Area

# Power Dissipation v Board Area





## Electrical Characteristics @TA = 25°C unless otherwise specified

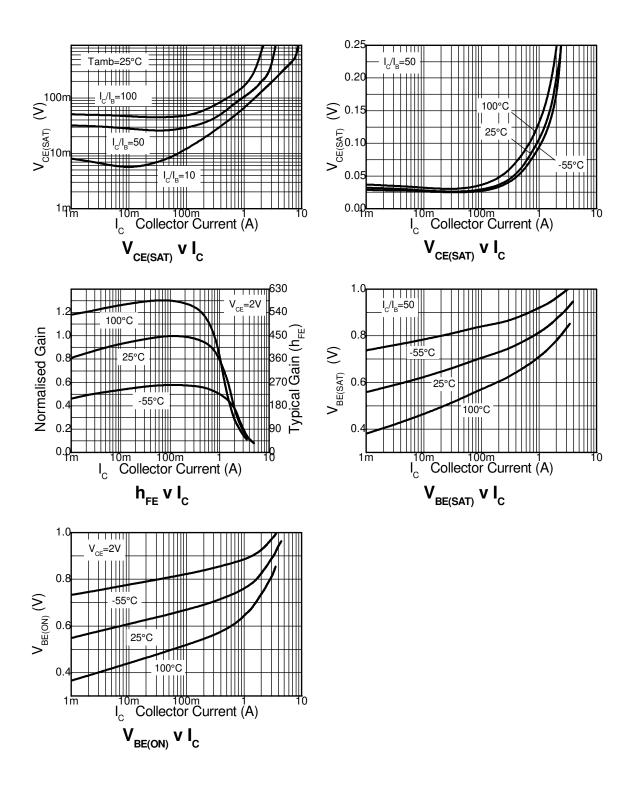
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	100	190	-	V	$I_C = 100\mu A$
Collector-Emitter Breakdown Voltage (Note 10)	V <sub>(BR)CEO</sub>	50	65	-	V	$I_C = 10mA$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	7	8.2	-	V	$I_E = 100\mu A$
Collector Cutoff Current	I <sub>CBO</sub>	-	-	100	nA	V <sub>CB</sub> = 80V
Emitter Cutoff Current	I <sub>EBO</sub>	-	-	100	. nA	V <sub>EB</sub> = 6V
Collector Emitter Cutoff Current	I <sub>CES</sub>	-	-	100	nA	V <sub>CES</sub> = 40V
Static Forward Current Transfer Ratio (Note 10)	hFE	200 300 200 100	400 450 400 225 40	- - - -	- - - -	$\begin{split} &I_{C} = 10 \text{mA}, \ V_{CE} = 2 \text{V} \\ &I_{C} = 200 \text{mA}, \ V_{CE} = 2 \text{V} \\ &I_{C} = 1 \text{A}, \ V_{CE} = 2 \text{V} \\ &I_{C} = 2 \text{A}, \ V_{CE} = 2 \text{V} \\ &I_{C} = 6 \text{A}, \ V_{CE} = 2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 10)	V <sub>CE(sat)</sub>	- - - -	10 70 145 115 225 270	20 100 200 220 300 320	mV mV mV mV mV	$\begin{split} &I_C = 0.1A,\ I_B = 10mA \\ &I_C = 1A,\ I_B = 50mA \\ &I_C = 1A,\ I_B = 10mA \\ &I_C = 2A,\ I_B = 50mA \\ &I_C = 3A,\ I_B = 100mA \\ &I_C = 4A,\ I_B = 200mA \end{split}$
Base-Emitter Turn-On Voltage (Note 10)	V <sub>BE(on)</sub>	-	0.94	1.00	V	I <sub>C</sub> = 4A, V <sub>CE</sub> = 2V
Base-Emitter Saturation Voltage (Note 10)	V <sub>BE(sat)</sub>	-	1.00	1.07	V	I <sub>C</sub> = 4A, I <sub>B</sub> = 200mA
Output Capacitance	C <sub>obo</sub>	-	12	20	pF	V <sub>CB</sub> = 10V. f = 1MHz
Transition Frequency	f <sub>T</sub>	100	165	-	MHz	V <sub>CE</sub> = 10V, I <sub>C</sub> = 50mA, f = 100MHz
Turn-on Time	t <sub>on</sub>	-	170	-	ns	$V_{CC} = 10V, I_{C} = 1A$
Turn-off Time	t <sub>off</sub>	-	750	-	ns	$I_{B1} = I_{B2} = 10mA$

Notes: 10. Measured under pulsed conditions. Pulse width  $\leq$  300  $\mu$ s. Duty cycle  $\leq$  2%





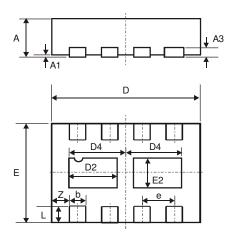
## **Typical Electrical Characteristics**





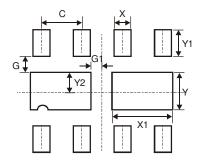


# **Package Outline Dimensions**



DFN3020B-8					
Dim	Min	Max	Тур		
Α	0.77	0.83	0.80		
A1	0	0.05	0.02		
A3	1	-	0.15		
b	0.25	0.35	0.30		
D	2.95	3.075	3.00		
D2	0.82	1.02	0.92		
D4	1.01	1.21	1.11		
е	-	-	0.65		
Е	1.95	2.075	2.00		
E2	0.43	0.63	0.53		
L	0.25	0.35	0.30		
Z	-	-	0.375		
All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)
С	0.650
G	0.285
G1	0.090
Х	0.400
X1	1.120
Υ	0.730
Y1	0.500
Y2	0.365





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